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With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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**Inolux Surface Mount High Power LED
IN-505FCHWV**

Official Product	Product: IN-505FCHWV			Data Sheet No.
Tentative Product	*****			IN-505FCHWV
Specifications are subject to change without notice. Data and drawings herein are copyrighted.		Oct. 03, 2014	Version of 1.0	Page 1/12

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DISCLAIMER

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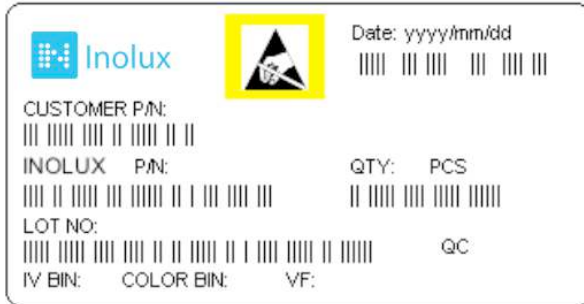
LIFE SUPPORT POLICY

INOLUX's products are not authorized for use as critical components in life support devices or systems without the express written approval of the President of INOLUX or INOLUX Technologies. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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Label Specifications



INOLUX P/N:

I N - 5 0 5 F C H W V - X X X X

Series Name	Substrate / Emitting Color	Customer Code
IN-505 Inolux 5050 package	FCHW - RGB White V - 700mA	XXXX Customer Product Code

Lot No.:

1	2	3	4	5	6	7	8	9	10
E	1	A	1	A	2	2	L	1	2
Code 1 2		Code 3	Code 4	Code 5	Code 6	Code 7	Code 8	Code 9	Code 10
		Mfg. Year	Mfg. Month	Mfg. Date	Consecutive number		Special code		
Internal Tracing Code		2010-A 2011-B 2012-C 2013-D . .	1:Jan. 2:Feb. ... A:Oct. B:Nov. C:Dec.	1:A 2:B 3:C ... 26:Z 27:7 28:8 29:9 30:3 31:4	01~ZZ		000~ZZZ		

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Product Characteristics
Absolute Maximum Ratings

 (T_j =25 °C)

Parameter	Symbol	Rating	Unit
DC Forward Current (mA)	I _f	700mA	mA
Peak Pulsing Current	I _{Peak}	1000mA	mA
Reverse Voltage	V _R	5	V
LED Junction Temperature	T _J	125°C	°C
LED Operating Temperature	T _{Opr}	-40°C ~ 85°C	°C
Storage Temperature	T _{Stg}	-40°C ~ 110°C	°C
Soldering Temperature at T _p (JEDEC-020-D)	T _{sol}	20~40 sec.	s
ESD Sensitivity	HBM	8,000V (MIL-STD-883G Class 3B)	V
	MM	400V (JESD22-A115-B Class C)	V

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Electro-Optical Characteristics
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(T_j 25 °C)

Part Number	Color	CCT / Dominate Wavelength		Luminous Flux (lm) @ 350mA	Luminous Flux (lm) @ 700mA	Forward Voltage @ 700mA	
		Min	Max			Min	Max
IN-505FCHWV	Red	620nm	630nm	>45	80-113.6	2.1	3.2
	Green	515nm	535nm	>100	150-195	3.2	4.2
	Blue	455nm	470nm	>18	25-39.8	3.2	4.0
	White	5000k	8300k	>100	180-220	3.2	4.0

Notes:

1. The peak/dominant wavelength is measured with an accuracy of ±1nm.
2. Luminous Flux is measured with an accuracy of ±10%
3. The forward voltage is measured with an accuracy of ±0.2V
4. Never operate the LEDs in reverse bias.
5. Do not drive at rated current for more than 5 seconds without proper thermal management.
6. When the LEDs are illuminating, operating current should be decided after considering the packages maximum temperature.
7. Caution: These devices emit high intensity light. Necessary precautions must be taken during operation. Do not look directly into the light or look through the optical system when in operation. Protective eyewear should be worn at all times during operation.

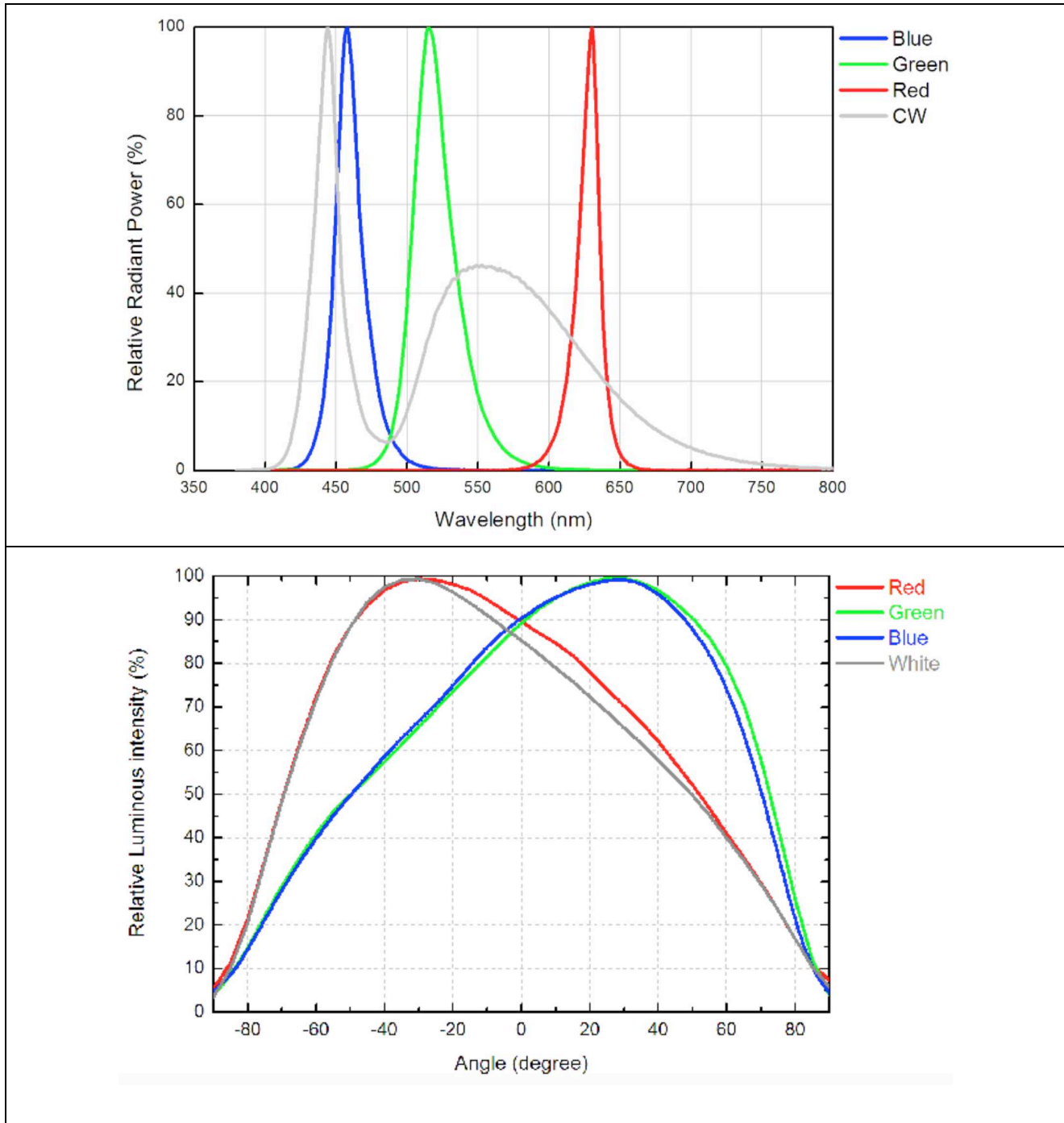
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**Package Outline Dimension
Recommended Soldering Pattern for Reflow Soldering**

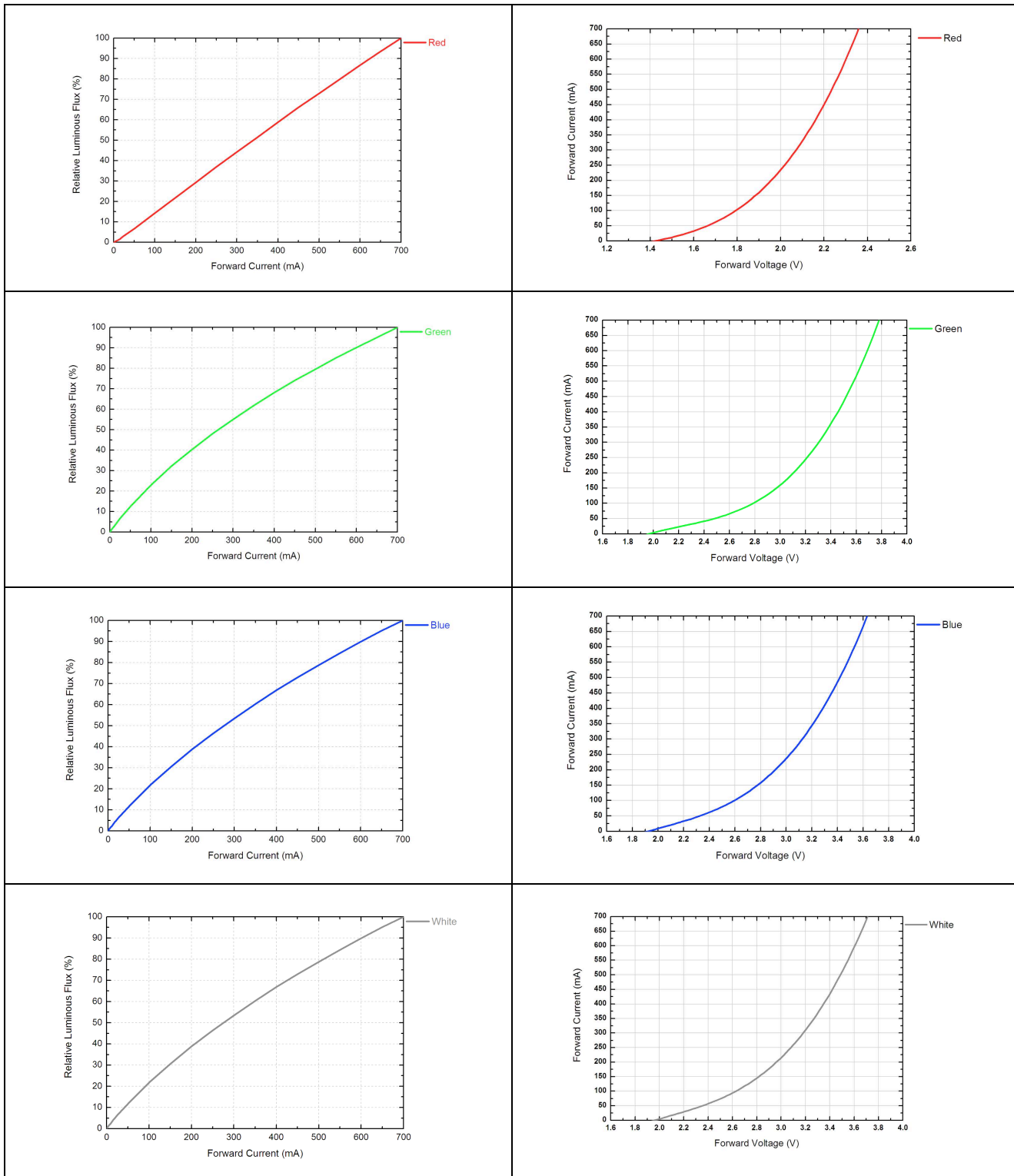
Unit: mm Tolerance: +/-0.13

Outline Dimension		Solder Pattern													
		<p>Recommended Soldering Pad Design</p>													
<p>(Marked Area is Opening)</p>		<table border="1"> <thead> <tr> <th>Chip</th> <th>Color</th> </tr> </thead> <tbody> <tr> <td>A</td> <td>Red</td> </tr> <tr> <td>B</td> <td>Green</td> </tr> <tr> <td>C</td> <td>Blue</td> </tr> <tr> <td>D</td> <td>White</td> </tr> <tr> <td>-</td> <td>-</td> </tr> </tbody> </table>		Chip	Color	A	Red	B	Green	C	Blue	D	White	-	-
Chip	Color														
A	Red														
B	Green														
C	Blue														
D	White														
-	-														
		<p>Soldering terminals may shift in the x, y direction.</p>													
		Unit: mm													

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Characteristic Curves


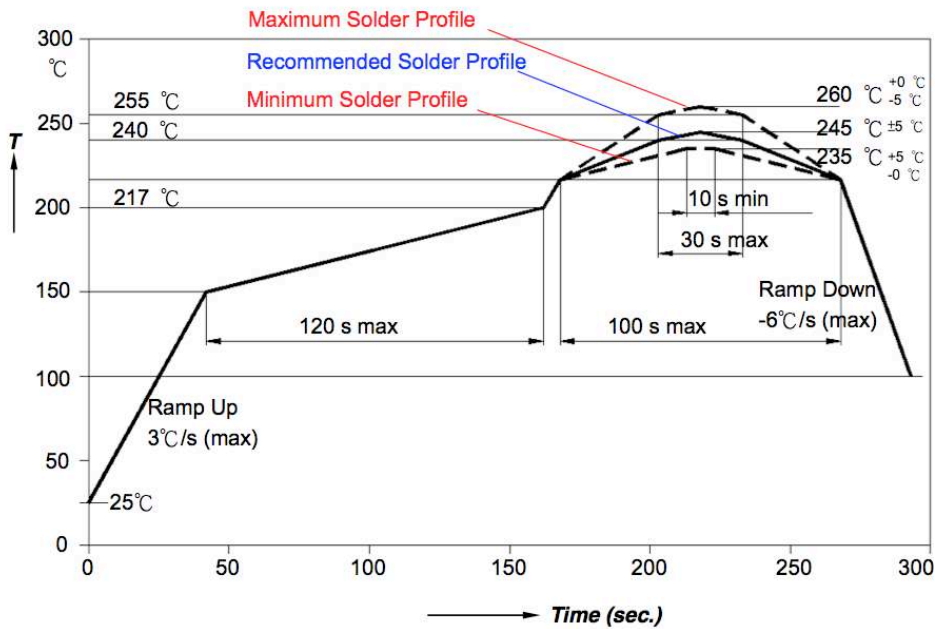
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Reflow Soldering

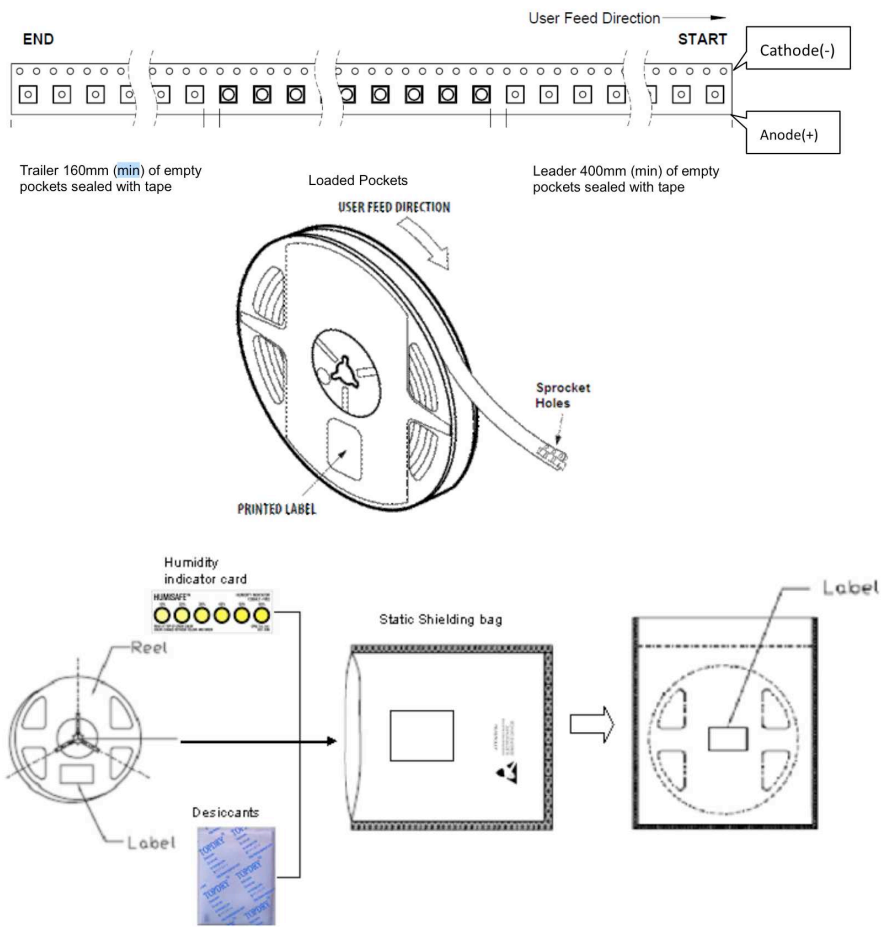
The LEDs can be soldered using the parameter listed below. As a general guideline, the users are suggested to follow the recommended soldering profile provided by the manufacturer of the solder paste. Although the recommended soldering conditions are specified in the list, reflow soldering at the lowest possible temperature is preferred for the LEDs.



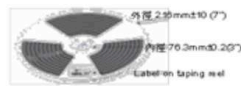
Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Average Ramp-up Rate (Ts _{max} to Tp)	3°C/second max.	3°C/second max.
Preheat		
- Temperature Min(Ts _{min})	100°C	150°C
- Temperature Max(Ts _{max})	150°C	200°C
- Time(ts _{min} to ts _{max})	60-120 seconds	60-180 seconds
Time maintained above:		
- Temperature(T _L)	183°C	217°C
- Time(t _L)	60-150 seconds	60-150 seconds
Peak/classification Temperature(Tp)	215°C	240°C
Time within 5°C of actual Peak Temperature(tp)	10-30 seconds	20-40 seconds
Ramp-Down Rate	6°C/second max.	6°C/second max.
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.

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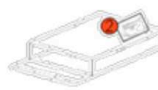
Packing Information



MFG Packing



Ship out packing Step



1 bag in an inner box= 400pcs

FG in after OQC Packing



1 reel in a bag = 400pcs



Small size: 5 inner box in an outer box= 2000pcs

Note : All Dimensions are in millimeter

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Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial release		1.0	10-03-2014

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